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Vishay Semiconductors

Insulated Gate Bipolar Transistor Ultralow V_{CE(on)}, 342 A



PRODUCT SUMMARY				
V _{CES}	600 V			
V _{CE(on)} (typical) at 200 A, 25 °C	1.33 V			
$I_{\rm C}$ at $T_{\rm C}$ = 97 °C ⁽¹⁾	200 A			

Note

⁽¹⁾ Maximum I_{RMS} current admitted 100 A to do not exceed the maximum temperature of terminals

FEATURES

- Standard: Optimized for minimum saturation voltage and low speed up to 5 kHz
- Lowest conduction losses available
- Fully isolated package (2500 V_{AC})
- Very low internal inductance (5 nH typical)
- Industry standard outline
- UL approved file E78996
- Compliant to RoHS directive 2002/95/EC
- Designed and qualified for industrial level

BENEFITS

- Designed for increased operating efficiency in power conversion: UPS, SMPS, TIG welding, induction heating
- Easy to assemble and parallel
- Direct mounting to heatsink
- Plug-in compatible with other SOT-227 packages

ABSOLUTE MAXIMUM RATINGS					
PARAMETER	SYMBOL	TEST CONDITIONS	MAX.	UNITS	
Collector to emitter breakdown voltage	V _{CES}		600	V	
Continuous collector current	I _C ⁽¹⁾	T _C = 25 °C	342		
Continuous collector current	IC (1)	T _C = 97 °C	200		
Pulsed collector current	I _{CM}	Repetitive rating; V_{GE} = 20 V, pulse width limited by maximum junction temperature See fig. 15	400	А	
Clamped Inductive load current	I _{LM}	$V_{CC} = 80 \% (V_{CES}), V_{GE} = 20 V,$ L = 10 µH, R _g = 2.0 Ω, See fig. 14			
Gate to emitter voltage	V _{GE}		± 20	V	
Reverse voltage avalanche energy	E _{ARV}	Repetitive rating; pulse width limited by maximum junction temperature	155	mJ	
RMS isolation voltage	VISOL	Any terminal to case, t = 1 minute	2500	V	
	Р	$T_{C} = 25 \ ^{\circ}C$	781	w	
Maximum power dissipation	P _D	T _C = 100 °C	312		
Operating junction and storage temperature range	T _J , T _{Stg}		- 55 to + 150	°C	
Mounting torque		6-32 or M3 screw	12 (1.3)	lbf \cdot in (N \cdot m)	

Note

⁽¹⁾ Maximum I_{RMS} current admitted 100 A to do not exceed the maximum temperature of terminals

THERMAL AND MECHANICAL SPECIFICATIONS					
PARAMETER	IETER SYMBOL TYP. MAX.		UNITS		
Junction to case	R _{thJC}	-	0.16	°C/W	
Case to sink, flat, greased surface	R _{thCS}	0.05	-	C/W	
Weight of module		30	_	g	



COMPLIANT



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Insulated Gate Bipolar Transistor Ultralow V_{CE(on)}, 342 A



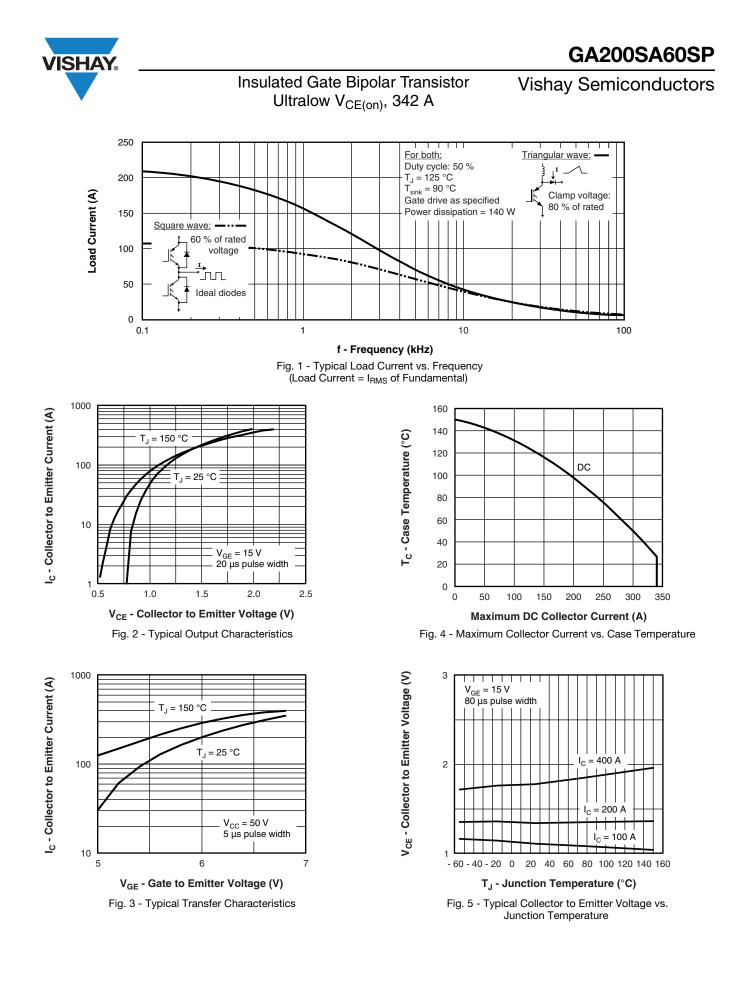
ELECTRICAL SPECIFICATIONS (T _J = 25 °C unless otherwise noted)							
PARAMETER	SYMBOL	TEST CONDITIONS		MIN.	TYP.	MAX.	UNITS
Collector to emitter breakdown voltage	V _{(BR)CES}	$V_{GE}=0~V,~I_C=250~\mu A$	$V_{GE} = 0 \text{ V}, \text{ I}_{C} = 250 \mu\text{A}$		-	-	v
Emitter to collector breakdown voltage	V _{(BR)ECS} ⁽¹⁾	$V_{GE} = 0 V, I_{C} = 1.0 A$		18	-	-	v
Temperature coeff. of breakdown voltage	$\Delta V_{(BR)CES} / \Delta T_J$	V _{GE} = 0 V, I _C = 1.0 mA		-	0.62	-	V/°C
Collector to emitter saturation voltage V _{CE(on)}		I _C = 100 A		-	1.10	1.3	
	V _{CE(on)}	I _C = 200 A	V _{GE} = 15 V See fig. 2, 5	-	1.33	-	v
	$I_{C} = 100 \text{ A}, T_{J} = 150 ^{\circ}\text{C}$	000 lig. 2, 0	-	1.02	-	v	
Gate threshold voltage	V _{GE(th)}	$V_{CE} = V_{GE}$, $I_C = 250 \ \mu A$		3.0	-	6.0	
Temperature coeff. of threshold voltage	$\Delta V_{GE(th)} / \Delta T_J$	$V_{CE} = V_{GE}$, $I_C = 2 \text{ mA}$		-	- 10	-	mV/°C
Forward transconductance	g _{fe} ⁽²⁾	$V_{CE} = 100 \text{ V}, \text{ I}_{C} = 100 \text{ A}$	ł	90	150	-	S
Zero gate voltage collector current I _{CES}	1	$V_{GE} = 0 V, V_{CE} = 600 V$		-	-	1.0	m 4
	V_{GE} = 0 V, V_{CE} = 10 V, T_{J} = 150 $^{\circ}\text{C}$		-	-	10	mA	
Gate to emitter leakage current	I _{GES}	V _{GE} = ± 20 V		-	-	± 250	nA

Notes

 $^{(1)}\,$ Pulse width $\leq 80~\mu s;~duty~factor \leq 0.1~\%$

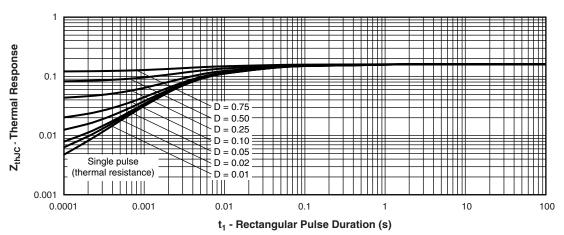
 $^{(2)}\,$ Pulse width 5.0 $\mu s,$ single shot

PARAMETER	SYMBOL	TEST CONDITIONS	MIN.	TYP.	MAX.	UNITS
Total gate charge (turn-on)	Qg	I _C = 100 A	-	770	1200	
Gate emitter charge (turn-on)	Q _{ge}	$V_{CC} = 400 V$	-	100	150	nC
Gate collector charge (turn-on)	Q _{gc}	V _{GE} = 15 V; See fig. 8	-	260	380	1
Turn-on delay time	t _{d(on)}	T ₁ = 25 °C	-	78	-	
Rise time	tr	$I_{\rm C} = 100 \rm{A}$	-	56	-	ns
Turn-off delay time	t _{d(off)}	$V_{\rm CC} = 480 \text{ V}$	-	890	1300	
Fall time	t _f	V _{GE} = 15 V	-	390	580	
Turn-on switching loss	E _{on}	$R_g = 2.0 \ \Omega$ Energy losses include "tail"	-	0.98	-	
Turn-off switching loss	E _{off}		-	17.4	-	mJ
Total switching loss	E _{ts}	See fig. 9, 10, 13	-	18.4	25.5	
Turn-on delay time	t _{d(on)}	T.I = 150 °C	-	72	-	
Rise time	tr	$I_{C} = 100$ A, $V_{CC} = 480$ V $V_{GE} = 15$ V, $R_{g} = 2.0 \Omega$ Energy losses include "tail" See fig. 10, 11, 13	-	60	-	1
Turn-off delay time	t _{d(off)}		-	1500	-	ns
Fall time	t _f		-	660	-	
Total switching loss	E _{ts}		-	35.7	-	mJ
Internal emitter inductance	L _E	Between lead, and center of the die contact	-	5.0	-	nH
Input capacitance	C _{ies}	V _{GE} = 0 V	-	16 250	-	
Output capacitance	C _{oes}	$V_{\rm CC} = 30$ V	-	1040	-	pF
Reverse transfer capacitance	C _{res}	f = 1.0 MHz; See fig. 7	_	190	-	1



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Insulated Gate Bipolar Transistor Ultralow $V_{CE(on)}$, 342 A





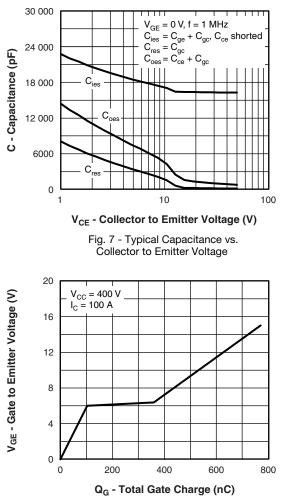
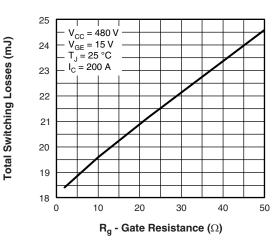
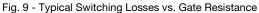
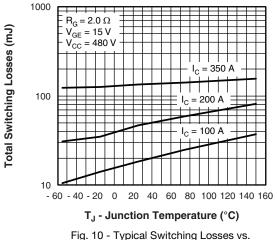


Fig. 8 - Typical Gate Charge vs. Gate to Emitter Voltage







Junction Temperature



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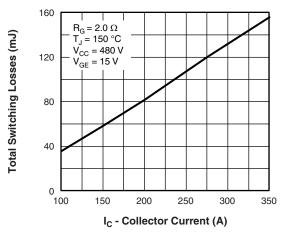
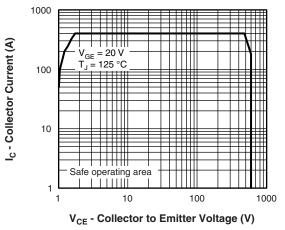
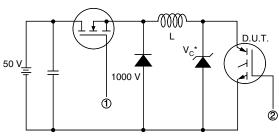


Fig. 11 - Typical Switching Losses vs. Collector Current

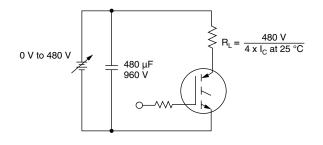




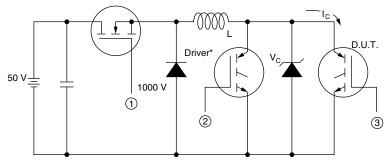


* Driver same type as D.U.T.; $V_C = 80$ % of V_{CE} (max) **Note:** Due to the 50 V power supply, pulse width and inductor will increase to obtain rated I_d

Fig. 13a - Clamped Inductive Load Test Circuit



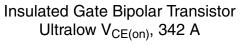




* Driver same type as D.U.T., V_{C} = 480 V

Fig. 14a - Switching Lost Test Circuit

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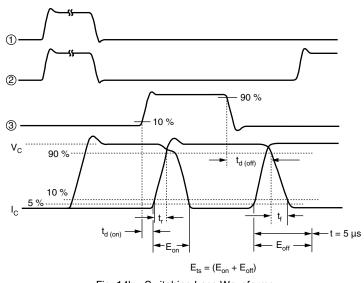


Fig. 14b - Switching Loss Waveforms

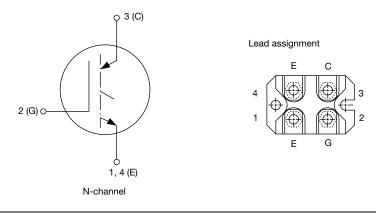
ORDERING INFORMATION TABLE

Device code G Α 200 S Α 60 S Ρ (2) ໌1 (5) (6)(7)(8) (3) (4)Insulated Gate Bipolar Transistor (IGBT) 2 3 4 5 6 Generation 4, IGBT silicon, DBC construction Current rating (200 = 200 A) Single switch, no diode SOT-227 Voltage rating (60 = 600 V) 7 Speed/type (S = Standard speed) -8 • None = Standard production • P = Lead (Pb)-free



Insulated Gate Bipolar Transistor Ultralow V_{CE(on)}, 342 A Vishay Semiconductors

CIRCUIT CONFIGURATION



LINKS TO RELATED DOCUMENTS			
Dimensions www.vishay.com/doc?95036			
Packaging information	www.vishay.com/doc?95037		

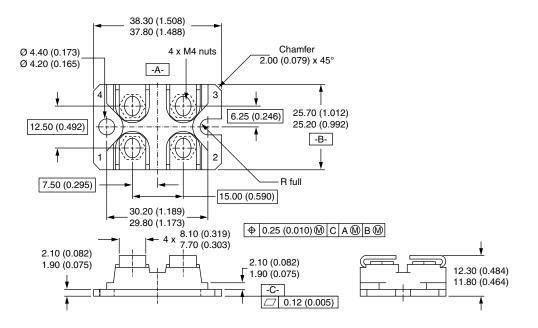


Outline Dimensions

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SOT-227

DIMENSIONS in millimeters (inches)



Notes

- Dimensioning and tolerancing per ANSI Y14.5M-1982
- Controlling dimension: millimeter



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